Direct electron imaging of energy filtered EBSD patterns using a CMOS hybrid pixel detector

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1. Aim and Overview

The aim of this work is to advance the capabilities of the electron backscatter diffraction (EBSD) technique, by using a digital CMOS hybrid pixel detector, Timepix [1], for the direct, energy filtered acquisition of EBSD patterns (EBSPs). Direct electron imaging combined with energy filtering allows the technique to achieve unprecedented performance. The detail, contrast and sharpness in energy filtered EBSPs is greatly improved compared to conventionally acquired patterns. This enhancement is stronger for lighter, less dense material. Such an approach could extend the applicability of EBSD to materials for which conventional EBSD analysis is not presently practicable.

4. Experimental results

Energy filtered imaging: The largest contribution to the diffraction patterns comes from low-loss electrons [2], that is electrons with an energy within 10% of the energy of the primary beam. High-loss electrons contribute with a diffuse, feature-less, background which covers the diffraction features.

Advantages of the energy filtering:

Improved contrast and sharpness in energy filtered EBSPs
Higher order diffraction features are observed
Improvement in the depth and lateral resolution of EBSD

2. Introduction

EBSD is a scanning electron microscope based technique used to obtain information from crystalline materials (metals, ceramics, semiconductors, geological minerals).



Conventionally an EBSD detector is composed of a combination of phosphor screen, optical lenses and CCD camera, used to image the diffraction pattern generated by backscattered electrons when a beam of electrons is focused in a point on the specimen surface.

Limitations:

Inefficient conversion of electrons to light and back to electrons

Intrinsic light scattering and optical interference within the phosphor

Intrinsic noise of the CCD camera

ØDistortion of the pattern due to the detector optics

Inability to select electrons having a specific energy range

3. Timepix detector

One of the most important





Beam energy: 20keV. Specimen tilt = 70°. Specimen-detector distance: \approx 1.5 cm. (a-c) Threshold energy: \approx 5 keV. (d-f) Threshold energy: \approx 19 keV.

Low energy imaging:



Gallium nitride

Reflection high-energy electron diffraction spots

characteristics of the Timepix Detector [1], the discriminator, allows the detection of only those particles having an energy above a specific, tunable, threshold value. This allows energy filtering at the detector (electronics) level.





Specimen-detector distance: ≈ 1 cm. Specimen tilt = 70°. (a) Silicon. Beam energy: 3.5 keV. (b) Gallium nitride. Beam energy: 5 keV.

5. References

[1] https://medipix.web.cern.ch/medipix/pages/medipix2/timepix.php
[2] A. Eades et al, in *Electron Backscatter Diffraction in Materials Science*, A.J. Schwartz et al. (eds.), 53-63, Springer (2009)

6. Acknowledgments

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Advantages:

Direct electron imaging

- Reduced exposure doses
- Reduced beam energies
- Working in noise-free condition
- Energy filtering
 Compact size